

Symbol	Parameter	Ratings	Units
BV <sub>CER</sub>	Collector to Emitter Breakdown Voltage (I <sub>C</sub> = 1mA)	400	V
BV <sub>ECS</sub>	Emitter to Collector Voltage - Reverse Battery Condition (I <sub>C</sub> = 10mA)	28	V
E <sub>SCIS25</sub>	Self Clamping Inductive Switching Energy (Note 1)	335	mJ
E <sub>SCIS150</sub>	Self Clamping Inductive Switching Energy (Note 2)	195	mJ
I <sub>C25</sub>	Collector Current Continuous, at V <sub>GE</sub> = 4.0V, T <sub>C</sub> = 25°C	26.9	Α
I <sub>C110</sub>	Collector Current Continuous, at V <sub>GE</sub> = 4.0V, T <sub>C</sub> = 110°C	25	Α
V <sub>GEM</sub>	Gate to Emitter Voltage Continuous	±10	V
р	Power Dissipation Total, at T <sub>C</sub> = 25°C	166	W
P <sub>D</sub>	Power Dissipation Derating, for T <sub>C</sub> > 25°C	1.1	W/ºC
TJ	Operating Junction Temperature Range	-40 to +175	°C
T <sub>STG</sub>	Storage Junction Temperature Range	-40 to +175	°C
TL	Max. Lead Temp. for Soldering (Leads at 1.6mm from case for 10s)	300	°C
T <sub>PKG</sub>	Max. Lead Temp. for Soldering (Package Body for 10s)	260	°C
ESD	Electrostatic Discharge Voltage at100pF, 1500 $\Omega$	4	kV

1

Package Marking and Ordering Information									
Device Marking Device		Package	age Reel Size Ta		Tape Width		Quantity		
FGB3440G2 FGB3440G2_F085		TO-263AB	330	)mm	24mm		800		
FGD3440G2 FGD3440G2_F085		TO-252AA	330	)mm	16mm		250	0	
FGF	FGP3440G2 FGP3440G2_F085		TO-220AB	Tu	lpe	N/A		50	
Electr	r	Cacteristics T <sub>A</sub> = 25° Parameter	C unless otherwise n		ions	Min	Тур	Мах	Units
	te Charact	eristics				1			
BV <sub>CER</sub>	Collector to E	Emitter Breakdown Voltage	$I_{CE} = 2mA, V_{GE} = 0,$ $R_{GE} = 1K\Omega,$ $T_{J} = -40 \text{ to } 150^{\circ}\text{C}$	1		370	400	430	V
BV <sub>CES</sub>	Collector to E	mitter Breakdown Voltage	$I_{CE} = 10mA, V_{GE} = 0V, R_{GE} = 0, T_{J} = -40 \text{ to } 150^{\circ}\text{C}$		390	420	450	V	
BV <sub>ECS</sub>	Emitter to Co	llector Breakdown Voltage	I <sub>CE</sub> = -20mA, V <sub>GE</sub> = T <sub>J</sub> = 25°C	0V,		28	-	-	V
BV <sub>GES</sub>	Gate to Emitter Breakdown Voltage		I <sub>GES</sub> = ±2mA		±12	±14	-	V	
	Collector to Emitter Leakage Current		$V_{CE}$ = 250V, $R_{GE}$ =1K $\Omega$	KΩ	T <sub>J</sub> = 25°C	-	-	25	μA
ICER		Initier Leakaye Guilent			T <sub>J</sub> = 150°C	-	-	1	mA
I <sub>ECS</sub>	Emitter to Co	llector Leakage Current	V <sub>EC</sub> = 24V,		$T_J = 25^{\circ}C$ $T_J = 150^{\circ}C$	-	-	1 40	mA
R <sub>1</sub>	Series Gate F	Resistance			1]=150°C		120	40	Ω
		(Colotarioc					120	_	22

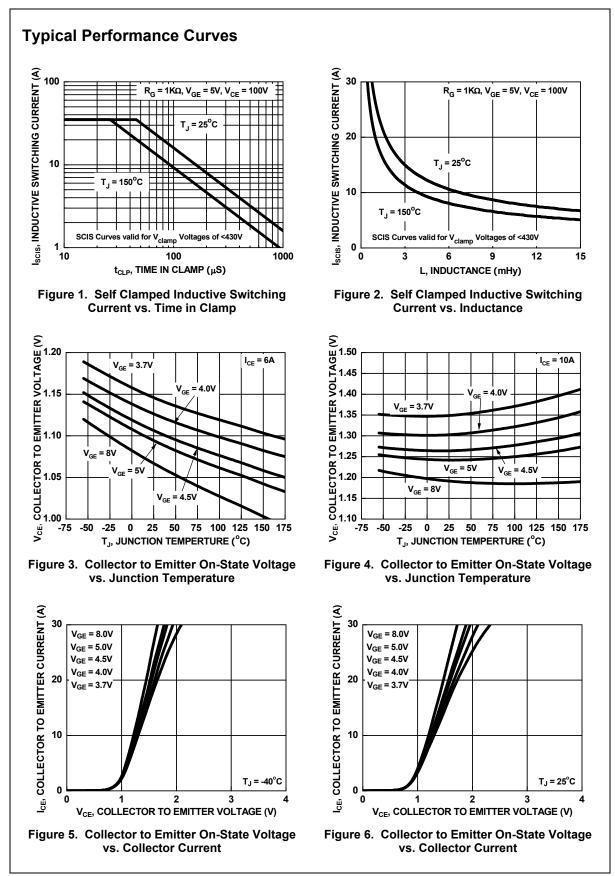
## **On State Characteristics**

V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE} = 6A, V_{GE} = 4V,$	$T_J = 25^{\circ}C$	-	1.1	1.2	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	I <sub>CE</sub> = 10A, V <sub>GE</sub> = 4.5V,	T <sub>J</sub> = 150 <sup>o</sup> C	-	1.3	1.45	V
V <sub>CE(SAT)</sub>	Collector to Emitter Saturation Voltage	$I_{CE} = 15A, V_{GE} = 4.5V,$	T <sub>J</sub> = 150 <sup>o</sup> C	-	1.6	1.75	V
E <sub>SCIS</sub>	Self Clamped Inductive Switching	L = 3.0 mHy, VGE = 5V RG = 1KΩ, (Note 1)	TJ = 25°C	-	-	335	mJ

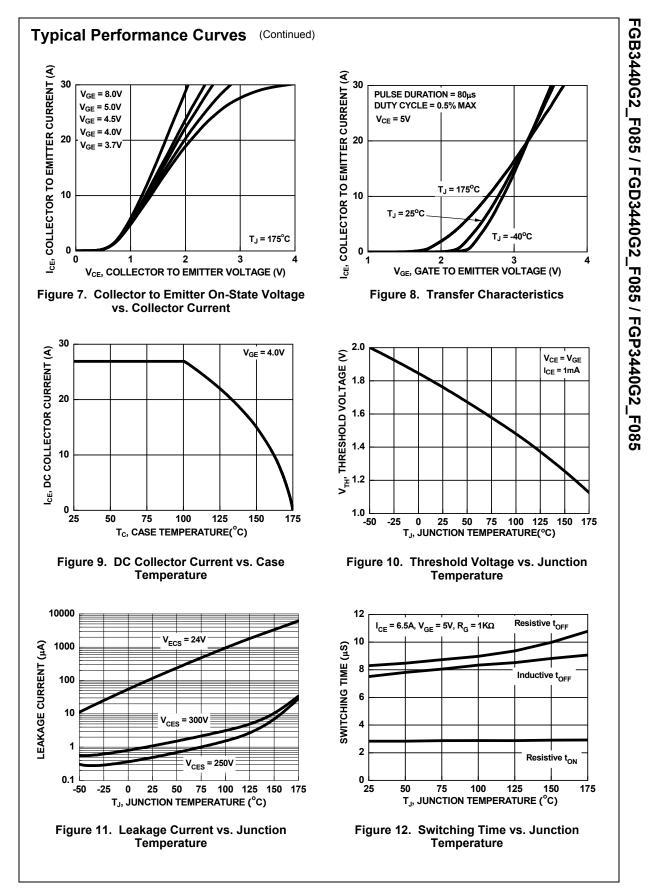
## Notes:

1: Self Clamping Inductive Switching Energy(Escis25) of 335mJ is based on the test conditions that is starting  $T_J=25$  °C; L=3mHy, I<sub>SCIS</sub>=15A,V<sub>CC</sub>=100V during inductor charging and V<sub>CC</sub>=0V during the time in clamp 2: Self Clamping Inductive Switching Energy (Escis150) of 195mJ is based on the test conditions that is starting  $T_J=150$  °C; L=3mHy, Iscis=11.4A,Vcc=100V during inductor charging and Vcc=0V during the time in clamp.

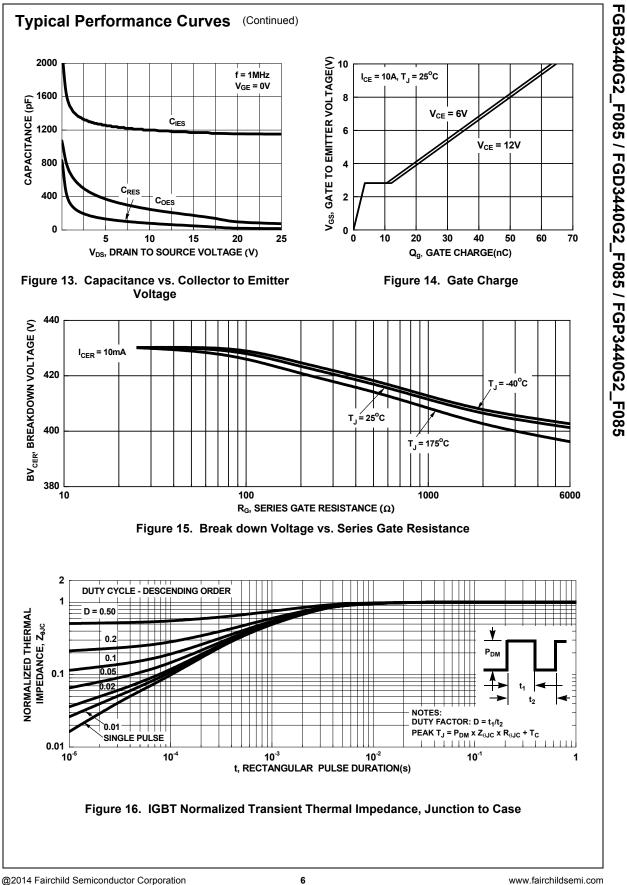
$V_{GE(TH)}$ Gate to Emitter Threshold Voltage $I_{CE} = 1mA$ , $V_{CE} = V_{GE}$ , $T_J = 25^{\circ}C$ $1.3$ $1.7$ $2.2$ $V$ $V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ - $2.8$ - $V$ witching Characteristics $(QON)R$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ - $1.0$ $4$ $\mu s$ $R$ Current Rise Time-Resistive $V_{GE} = 5V$ , $R_G = 1K\Omega$ - $2.0$ $7$ $\mu s$ $(1OFF)L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V$ , $L = 1mH$ , $V_{GE} = 5V$ , $R_G = 1K\Omega$ - $5.3$ $15$ $\mu s$ $(1OFF)L$ Current Fall Time-Inductive $V_{CE} = 30V$ , $L = 1mH$ , $V_{GE} = 5V$ , $R_G = 1K\Omega$ - $2.3$ $15$ $\mu s$ hermal Characteristics	Symbol	Parameter	Test Condit	tions	Min	Тур	Max	Units
$U_{G(ON)}$ Gate Charge $V_{GE} = 5V$ $ 24$ $ 11C$ $V_{GE(TH)}$ Gate to Emitter Threshold Voltage $I_{CE} = 1mA, V_{CE} = V_{GE},$ $T_J = 25^{\circ}C$ $1.3$ $1.7$ $2.2$ $V$ $V_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ $ 2.8$ $ V$ emitter Plateau Voltage $V_{CE} = 12V, I_{CE} = 10A$ $ 2.8$ $ V$ emitter Plateau Voltage $V_{CE} = 14V, R_L = 10A$ $ 2.8$ $ V$ emitter Turn-On Delay Time-Resistive $V_{CE} = 14V, R_L = 10A$ $ 1.0$ $4$ $\mu$ s $V_{GE} = 5V, R_G = 1K\Omega$ $R$ Current Rise Time-Resistive $V_{CE} = 300V, L = 1mH,$ $ 2.0$ $7$ $\mu$ s $M(OFF)L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ $ 5.3$ $15$ $\mu$ s $L$ Current Fall Time-Inductive $V_{CE} = 5V, R_G = 1K\Omega$ $ 2.3$ $15$ $\mu$ s $L_L$ Current Fall Time-Inductive $V_{CE} = 5V, R_G = 1K\Omega$ $ 2.3$ $15$ $\mu$ shermal Characteristics	Dynam	ic Characteristics						
	Q <sub>G(ON)</sub>	Gate Charge			-	24	-	nC
$T_{GEP}$ Gate to Emitter Plateau Voltage $V_{CE} = 12V$ , $I_{CE} = 10A$ -2.8-Vwitching Characteristics $I_{(ON)R}$ Current Turn-On Delay Time-Resistive $V_{CE} = 14V$ , $R_L = 1\Omega$ -1.04 $\mu$ s $R$ Current Rise Time-Resistive $V_{GE} = 5V$ , $R_G = 1K\Omega$ -2.07 $\mu$ s $I_{(OFF)L}$ Current Turn-Off Delay Time-Inductive $V_{CE} = 30V$ , $L = 1mH$ ,-5.315 $\mu$ s $L$ Current Fall Time-Inductive $V_{GE} = 5V$ , $R_G = 1K\Omega$ -2.315 $\mu$ shermal Characteristics	V <sub>GE(TH)</sub>	Gate to Emitter Threshold Voltage						v
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	V <sub>GEP</sub>	Gate to Emitter Plateau Voltage	V <sub>CE</sub> = 12V, I <sub>CE</sub> = 10A	Ū	-		-	V
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	Switchi	ng Characteristics						
RCurrent Rise Time-Resistive $T_J = 25^{\circ}C$ ,-2.07 $\mu s$ $d(OFF)L$ Current Turn-Off Delay Time-Inductive $V_{CE} = 300V, L = 1mH,$ -5.315 $\mu s$ LCurrent Fall Time-Inductive $V_{GE} = 5V, R_G = 1K\Omega$ -2.315 $\mu s$ Hermal Characteristics	t <sub>d(ON)R</sub>				-	1.0	4	μS
$\begin{array}{c c c c c c c c c c c c c c c c c c c $	t <sub>rR</sub>	Current Rise Time-Resistive			-	2.0	7	μS
$I_{CE} = 6.5A, T_{J} = 25^{\circ}C,$ hermal Characteristics	d(OFF)L	Current Turn-Off Delay Time-Inductive	V <sub>CE</sub> = 300V, L = 1mH,		-	5.3	15	μS
hermal Characteristics	t <sub>fL</sub>	Current Fall Time-Inductive	$V_{GE} = 5V, R_G = 1K\Omega$ $I_{CE} = 6.5A, T_1 = 25^{\circ}C.$		-	2.3	15	μS
			l					-
					-	-	0.9	<u>°C/W</u>



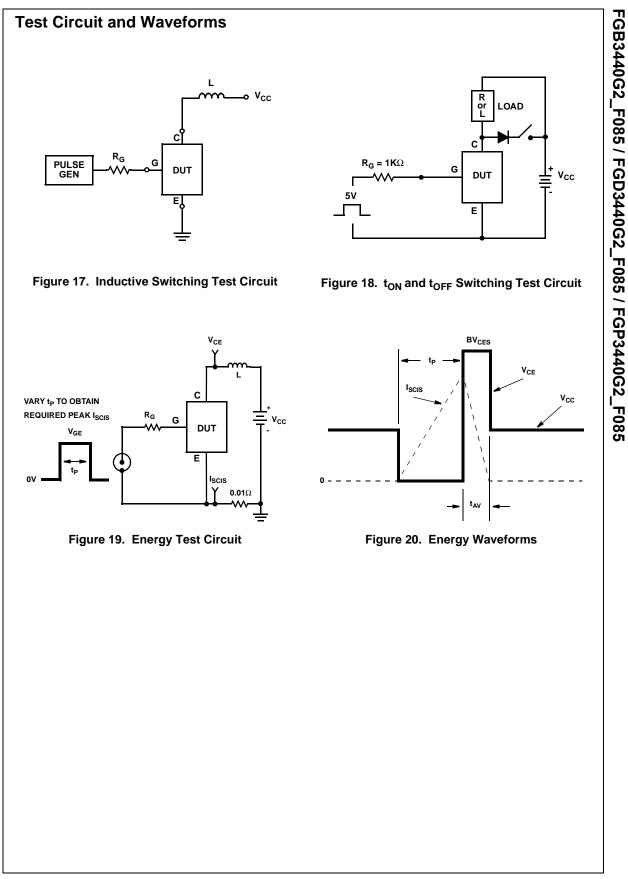




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Datasheet Identification	Product Status	Definition
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
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